

RoHS

COMPLIANT

HALOGEN FREE

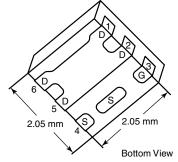
Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω) (Max.)	I _D (A) ^a	Q _g (Typ.)	
30	0.018 at V _{GS} = 10 V	12		
	0.020 at V _{GS} = 6 V	12	5 nC	
	0.022 at V _{GS} = 4.5 V	12		

PowerPAK SC-70-6L-Single

SiA462DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)



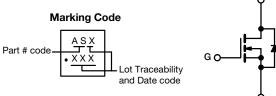
Ordering Information:

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % Rg Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- DC/DC Converters and Synchronous Buck Converters
 - Lower Ringing Voltage from Soft Turn-On
 - High Efficiency from Fast Turn-Off
 - Lower Shoot-Through Possibility





ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \degree C$, unle Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30		
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C		12 ^a		
	T _C = 70 °C	1-	12 ^a		
	T _A = 25 °C	I _D	12 ^{a,b, c}		
	T _A = 70 °C		9.7 ^{b, c}	А	
Pulsed Drain Current (t = 300 μs)		I _{DM}	40		
Continuous Courses Drain Diada Current	T _C = 25 °C	la la	12 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.9 ^{b, c}		
	T _C = 25 °C		19		
Maximum Power Dissipation	T _C = 70 °C	P _D	12	w	
	T _A = 25 °C	ГD	3.5 ^{b, c}	vv	
	T _A = 70 °C		2.2 ^{b, c}	1	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	28	36	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	5.3	6.5		

Notes:

a. Based on package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See solder profile (www.vishav.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 80 °C/W.

Document Number: 63269

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S13-0628-Rev. A, 25-Mar-13

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•		•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V$, $I_{D} = 250 \mu A$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		34		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η _D = 250 μΑ		- 5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		2.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zarra Casta Malta na Drain Currant	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, $V_{GS} = 10$ V	10			Α	
	R _{DS(on)}	V _{GS} = 10 V, I _D = 9 A		0.015	0.018	+	
Drain-Source On-State Resistance ^a		V _{GS} = 6 V, I _D = 7 A		0.016	0.020	Ω	
		$V_{GS} = 4.5 \text{ V}, I_{D} = 7 \text{ A}$		0.018	0.022	1	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 9 A		35		S	
Dynamic ^b	<u> </u>			1	I		
Input Capacitance	C _{iss}			570		pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		126			
Reverse Transfer Capacitance	C _{rss}	20 00		52			
·		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 12 A		11	17	<u> </u>	
Total Gate Charge	Qg			5	7.5	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 12 \text{ A}$		1.7			
Gate-Drain Charge	Q _{gd}			1.6			
Gate Resistance	R _g	f = 1 MHz	0.2	1	2	Ω	
Turn-On Delay Time	t _{d(on)}			5	10		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$		10	20	- ns 	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		15	30		
Fall Time	t _f	-		10	20		
Turn-On Delay Time	t _{d(on)}			12	25		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$		15	30		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		15	30		
Fall Time	t _f	Ŭ		10	20		
Drain-Source Body Diode Characteristic	s				L	1	
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			12		
Pulse Diode Forward Current ^a	I _{SM}				40	A	
Body Diode Voltage	V _{SD}	I _S = 10 A		0.85	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	-		20	40	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			11	20	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		12			
Reverse Recovery Rise Time		t _b		8		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

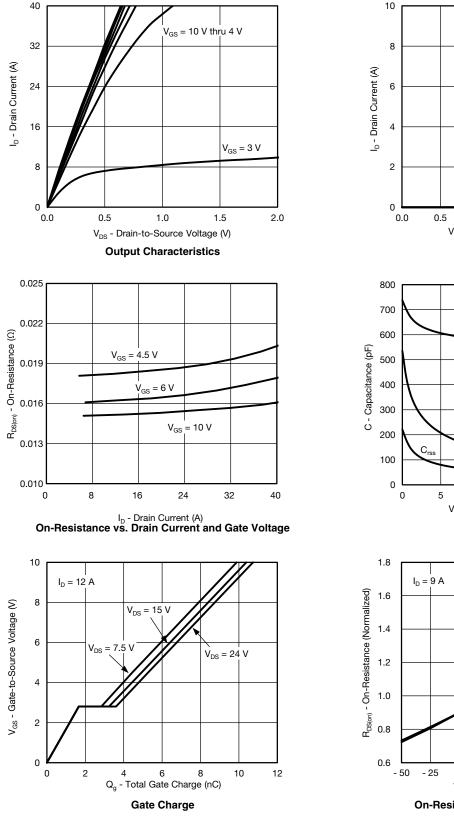
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

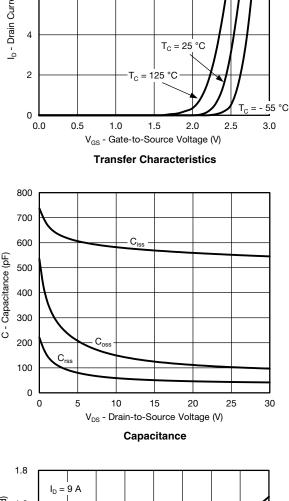
Document Number: 63269 S13-0628-Rev. A, 25-Mar-13

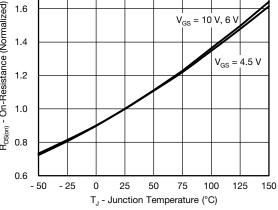


SiA462DJ Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







On-Resistance vs. Junction Temperature

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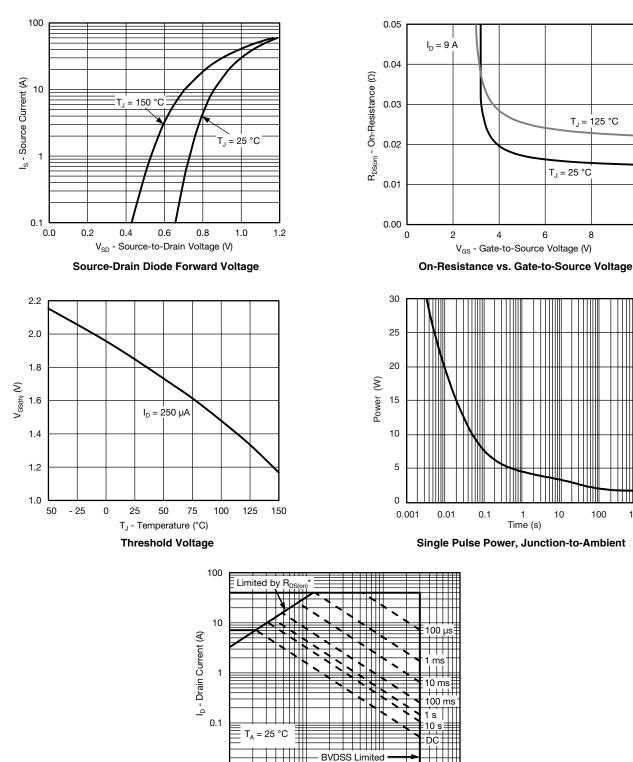
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Document Number: 63269

S13-0628-Rev. A, 25-Mar-13

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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 $\label{eq:V_DS} \begin{array}{l} V_{DS} \text{ - Drain-to-Source Voltage (V)} \\ ^{*}V_{GS} > \text{minimum } V_{GS} \text{ at which } R_{DS(on)} \text{ is specified} \\ \begin{array}{l} \textbf{Safe Operating Area, Junction-to-Ambient} \end{array}$

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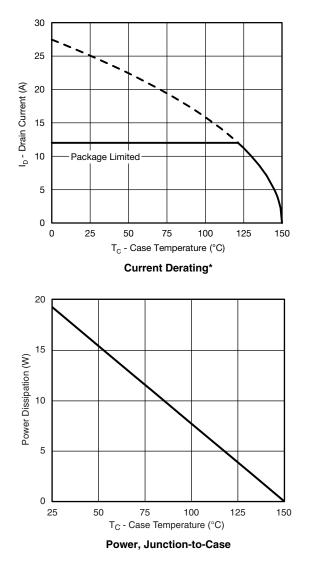
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

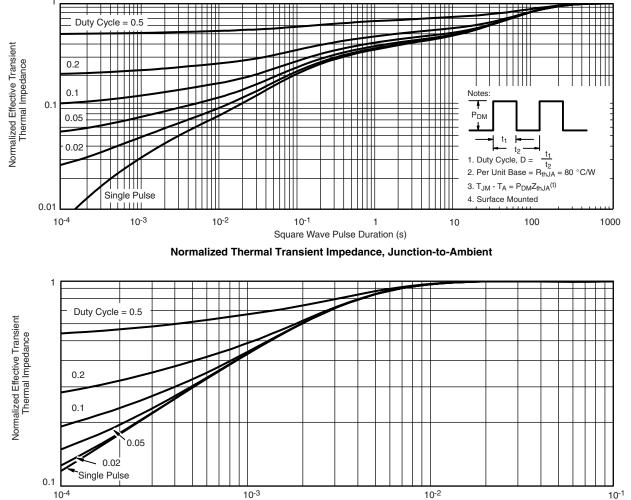


* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63269.

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Document Number: 63269 S13-0628-Rev. A, 25-Mar-13



PowerPAK[®] SC70-6L

VISHA

b PIN2 PIN1 PIN3 _ ₹



b

PIN3

__ ₿

PIN2

PIN1

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RECOMMENDED PAD LAYOUT FOR PowerPAK[®] SC70-6L Single



Dimensions in mm/(Inches)

Return to Index



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